

07/10/01  
jc962 U.S. PTO

07-11-01

Atty. Docket No. AMAT/4180/PDD/KPU/JW

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07/10/01  
jc997 U.S. PTO  
09/902518

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Box Patent Application  
Assistant Commissioner of Patents and Trademarks  
Washington, D.C. 20231

Re: Inventor(s): Kegang Huang; Judy H. Huang; and Ping Xu  
Title: Method and Apparatus for Treating Low K Dielectric Layers to Reduce Diffusion

Transmitted herewith is the patent application identified above, including:

Specification, claims and abstract, totaling 24 pages.  
 Drawings totaling 5 pages, 6 Formal   Informal.  
 Declaration and Power of Attorney (Unsigned).  
 Information Disclosure Statement w/ Form 1449 and References.  
 Assignment of the invention to **Applied Materials, Inc.**

### Assignment Recordation Cover Sheet

<b>FEE CALCULATION</b>					
Fee Items	Claims Filed	Included With Basic Fee	Extra Claims	Fee Rate	Total
Total Claims	31	-20=	11	x \$18.00	-- \$ 198.00
Independent Claims	3	-3=	0	x \$80.00	-- \$ 0.00
Basic Filing Fee		\$710.00		\$710.00	
<b>TOTAL FEES</b>					<b>\$ 908.00</b>

The Commissioner is hereby authorized to charge \$908.00 to Deposit Account No. AMAT/4180/PDD/KPU/JW.

The Commissioner is hereby authorized to charge any additional fees which may be required, or credit any overpayment to Deposit Account No. AMAT/4180/PDD/KPU/JW. A duplicate copy of this transmittal is enclosed.

Please address all future correspondence to:

**PATENT COUNSEL  
APPLIED MATERIALS, INC.  
Legal Affairs Department  
P.O.BOX 450A  
Santa Clara, CA. 95052**

I hereby certify that this correspondence is being deposited with the United States Postal Service as express mail in an envelope addressed to: Commissioner of Patents and Trademarks, Washington, D.C. 20231.

Respectfully submitted,

*Keith M. Tackett*

Keith M. Tackett  
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Express Mail Receipt No: EL 849164749 US.

Date of Deposit: July 10, 2001.

Signature: Keith M. Tackett.